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Vishay Siliconix

# N-Channel 25 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	25					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.00058					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.00082					
Q <sub>g</sub> typ. (nC)	54					
I <sub>D</sub> (A) <sup>a</sup>	335					
Configuration	Single					

#### **FEATURES**

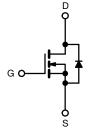
- TrenchFET® Gen IV power MOSFET
- Very low R<sub>DS</sub> x Q<sub>g</sub> figure-of-merit (FOM)



- Leadership R<sub>DS(on)</sub> minimizes power loss from conduction
- 100 % R<sub>a</sub> and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Battery management
- DC/DC converters
- · Hot swap switch
- OR-ing FET



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8
Lead (Pb)-free and halogen-free	SIRA20BDP-T1-GE3

ABSOLUTE MAXIMUM RATING	<b>iS</b> (T <sub>A</sub> = 25 °C, u	ınless otherv	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	25	V	
Gate-source voltage		$V_{GS}$	+16 / -12	v	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		335		
	T <sub>C</sub> = 70 °C	1 .	268		
	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	82 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	66 <sup>b, c</sup>	А	
Pulsed drain current (t = 100 μs)		I <sub>DM</sub>	500	A	
Continuous source durin diade current	T <sub>C</sub> = 25 °C		94.5		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		5.6 b, c		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	90		
Single pulse avalanche energy	L = 0.1 MH	E <sub>AS</sub>	405	mJ	
	T <sub>C</sub> = 25 °C		104		
Mayimum nauyar dinainatian	T <sub>C</sub> = 70 °C		67	w	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	6.3 b, c	VV	
	T <sub>A</sub> = 70 °C		4 b, c		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperate	Soldering recommendations (peak temperature) c		260		

THERMAL RESISTANCE RATING	GS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	0.9	1.2	] C/VV

## Notes

of the second state of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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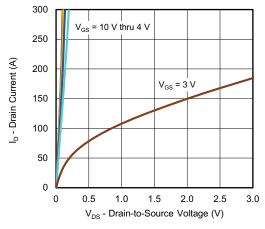
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•	<u> </u>	
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	25	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 10 mA	-	17	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.4	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.0	-	2.1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = +16 \text{ V} / -12 \text{ V}$	-	-	± 100	nA	
Zara gata valtaga drain augusat		V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V	-	-	1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 25 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40	-	-	Α	
Drain accuracy on state registeres a	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	0.00048	0.00058	0	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	0.00063	0.00082	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 60 A		197	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>			9950	-		
Output capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		3140	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	230	-		
Table also de con		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	-	124	186	3	
Total gate charge	Q <sub>g</sub>		-	54	81		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$	-	30	-	nC	
Gate-drain charge	Q <sub>gd</sub>		-	6.2	-		
Output charge	Q <sub>oss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V	-	91	-		
Gate resistance	$R_g$	f = 1 MHz	0.2	0.9	1.8	Ω	
Turn-on delay time	t <sub>d(on)</sub>			17	35		
Rise time	t <sub>r</sub>	$V_{DD} = 10 \text{ V}, \text{ R}_L = 0.5 \Omega, \text{ I}_D \cong 20 \text{ A},$	-	6	15		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		55	110		
Fall time	t <sub>f</sub>			7	15		
Turn-on delay time	t <sub>d(on)</sub>			50	100	ns	
Rise time	t <sub>r</sub>	$V_{DD}=10~V,~R_L=0.5~\Omega,~I_D\cong20~A,$		65	130		
Turn-off delay time	t <sub>d(off)</sub>	$V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		60	120		
Fall time	t <sub>f</sub>		-	25	50		
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	94.5	^	
Pulse diode forward current	I <sub>SM</sub>		-	-	350	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.72	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	56	110	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	75	150	nC	
Reverse recovery fall time	ta	$T_J = 25  ^{\circ}C$	-	30	-	nc	
Reverse recovery rise time	t <sub>b</sub>		-	26	-	ns	

#### Notes

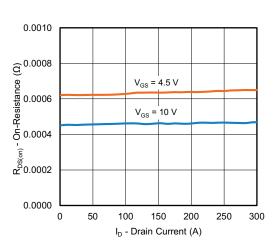
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

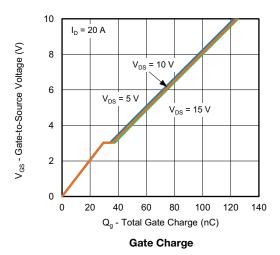


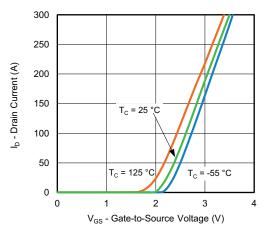


#### **Output Characteristics**

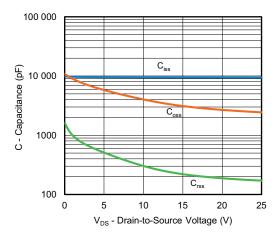


On-Resistance vs. Drain Current and Gate Voltage

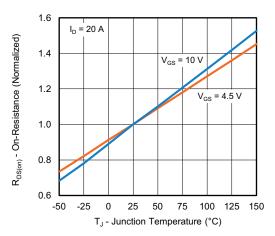




**Transfer Characteristics** 

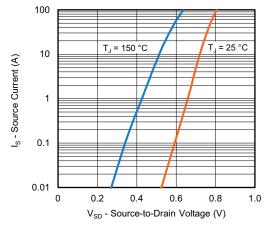


Capacitance

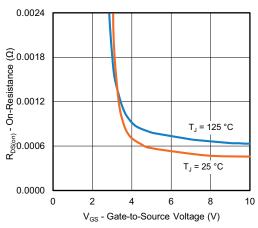


On-Resistance vs. Junction Temperature

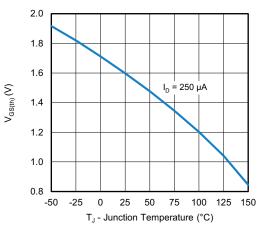




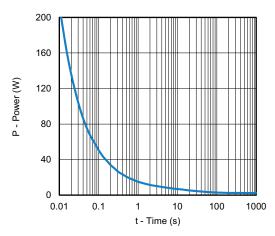
#### Source-Drain Diode Forward Voltage



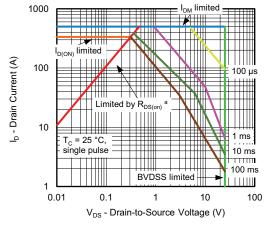
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



Single Pulse Power, Junction-to-Ambient

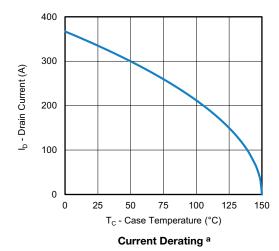


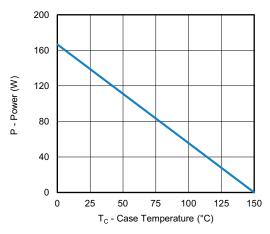
Safe Operating Area, Junction-to-Ambient

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified





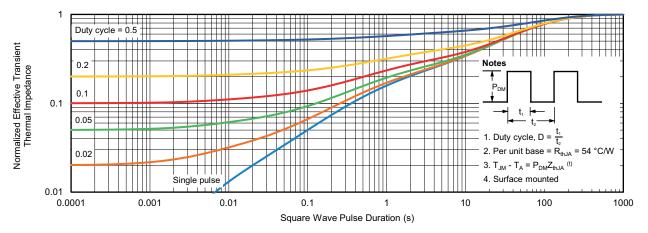


Power, Junction-to-Case

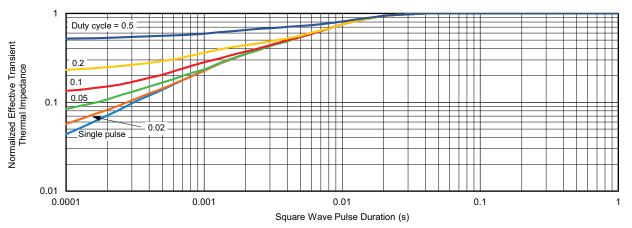
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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# PowerPAK® SO-8, (Single/Dual)



DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX	
Α	0.97	1.04	1.12	0.038	0.041	0.044	
A1		-	0.05	0	-	0.002	
b	0.33	0.41	0.51	0.013	0.016	0.020	
С	0.23	0.28	0.33	0.009	0.011	0.013	
D	5.05	5.15	5.26	0.199	0.203	0.207	
D1	4.80	4.90	5.00	0.189	0.193	0.197	
D2	3.56	3.76	3.91	0.140	0.148	0.154	
D3	1.32	1.50	1.68	0.052	0.059	0.066	
D4		0.57 typ.		0.0225 typ.			
D5		3.98 typ.		0.157 typ.			
E	6.05	6.15	6.25	0.238	0.242	0.246	
E1	5.79	5.89	5.99	0.228	0.232	0.236	
E2	3.48	3.66	3.84	0.137	0.144	0.151	
E3	3.68	3.78	3.91	0.145	0.149	0.154	
E4		0.75 typ.		0.030 typ.			
е		1.27 BSC		0.050 BSC			
K		1.27 typ.		0.050 typ.			
K1	0.56	-	-	0.022	-	-	
Н	0.51	0.61	0.71	0.020	0.024	0.028	
L	0.51	0.61	0.71	0.020	0.024	0.028	
L1	0.06	0.13	0.20	0.002	0.005	0.008	
θ	0°	=	12°	0°	-	12°	
W	0.15	0.25	0.36	0.006	0.010	0.014	
M	0.125 typ.			0.005 typ.			

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# RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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